BT131 series

Triacs logic level

GENERAL DESCRIPTION

Passivated, sensitive gate triacs in a plastic envelope, intended for use in general purpose bidirectional switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

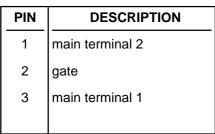
PINNING - TO92

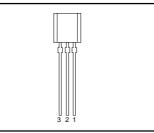
QUICK REFERENCE DATA

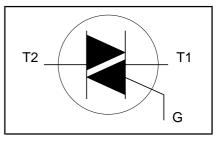
SYMBOL	PARAMETER	MAX.	MAX.	UNIT
	BT131-	600	800	
V _{DRM} I _{T(RMS)}	Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state	600 1	800 1	V A
ITSM	current	16	16	А

PIN CONFIGURATION

SYMBOL







LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
V _{DRM}	Repetitive peak off-state voltages		-	-600 600 ¹	-800 800	V
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{lead} \le 74 \degree C$ full sine wave; $T_j = 25 \degree C$ prior to surge	-		1	A
		t = 20 ms t = 16.7 ms	-		6 7.6	A
l ² t	I ² t for fusing	t = 10 ms	-		28	A A ² s
dl _⊤ /dt	Repetitive rate of rise of on-state current after	I _{TM} = 1.5 A; I _G = 0.2 A; dI _G /dt = 0.2 A/μs				
	triggering	T2+G+	-		0	A/μs
		T2+ G-	-		0	A/μs
		T2- G- T2- G+	-		0	A/μs
I	Peak gate current	12- 6+	-		0	A/μs A
I _{GM} Р _{GM}	Peak gate power		_		2 5	Ŵ
	Average gate power	over any 20 ms period	-		.5	W
T _{stg} T _j	Storage temperature Junction temperature		-40 -	15	50 25	О° О

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 3 A/μs.

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-lead} R _{th j-a}	Thermal resistance junction to lead Thermal resistance junction to ambient	full cycle half cycle pcb mounted;lead length = 4mm		- - 150	60 80 -	K/W K/W K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{GT}	Gate trigger current	$V_{\rm D} = 12 \text{ V}; I_{\rm T} = 0.1 \text{ A}$				
01		T2+G+	-	0.4	3	mA
		T2+ G-	-	1.3	3	mA
		T2- G-	-	1.4	3	mA
		T2- G+	-	3.8	7	mA
l I _L	Latching current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$				
_		T2+G+	-	1.2	5	mA
		T2+ G-	-	4.0	8	mA
		T2- G-	-	1.0	5	mA
		T2- G+	-	2.5	8	mA
I _H	Holding current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$	-	1.3	5	mA
I _H V _T V _{GT}	On-state voltage	$I_{T} = 2.0 \text{ A}$	-	1.2	1.5	V
V _{GT}	Gate trigger voltage	$V_{\rm D} = 12 \text{ V}; I_{\rm T} = 0.1 \text{ A}$	-	0.7	1.5	V
		$V_{\rm D} = 400 \text{ V}; I_{\rm T} = 0.1 \text{ A}; T_{\rm i} = 125 \text{ °C}$	0.2	0.3	-	V
I _D	Off-state leakage current	$V_{D} = 12 V; I_{T} = 0.1 A$ $V_{D} = 400 V; I_{T} = 0.1 A; T_{j} = 125 °C$ $V_{D} = V_{DRM(max)}; T_{j} = 125 °C$	-	0.1	0.5	mA

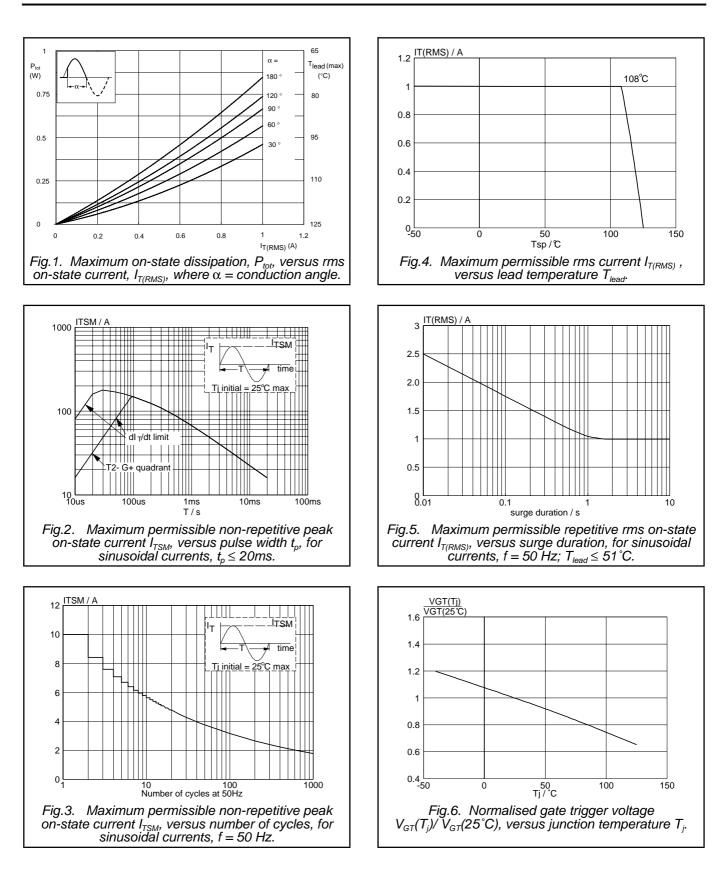
DYNAMIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV _D /dt	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$ exponential waveform; $R_{GK} = 1 k\Omega$	5	15	-	V/µs
t _{gt}		$I_{TM} = 1.5 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A}; dI_G/dt = 5 \text{ A}/\mu \text{s}$	-	2	-	μs

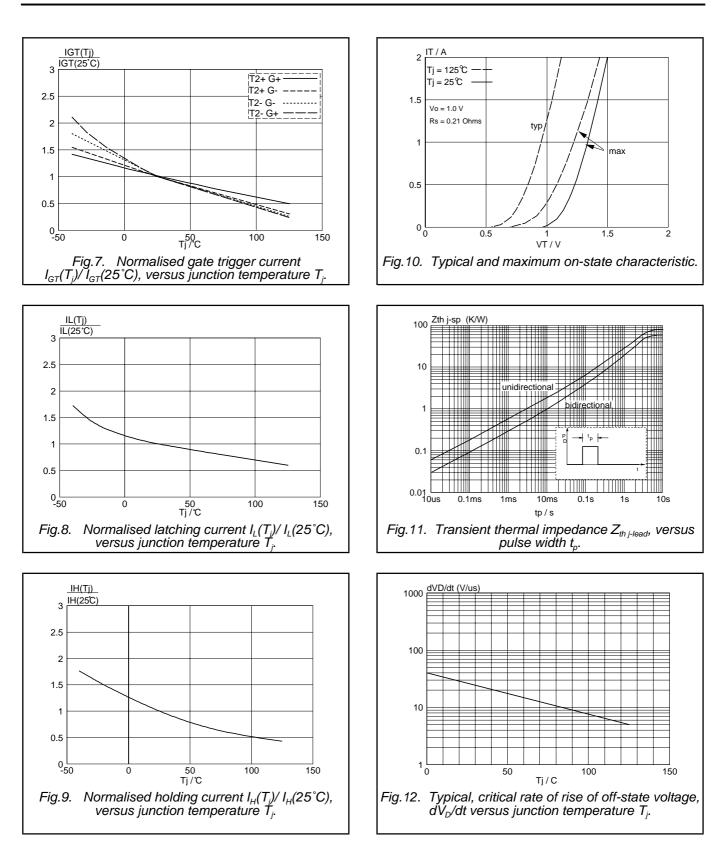
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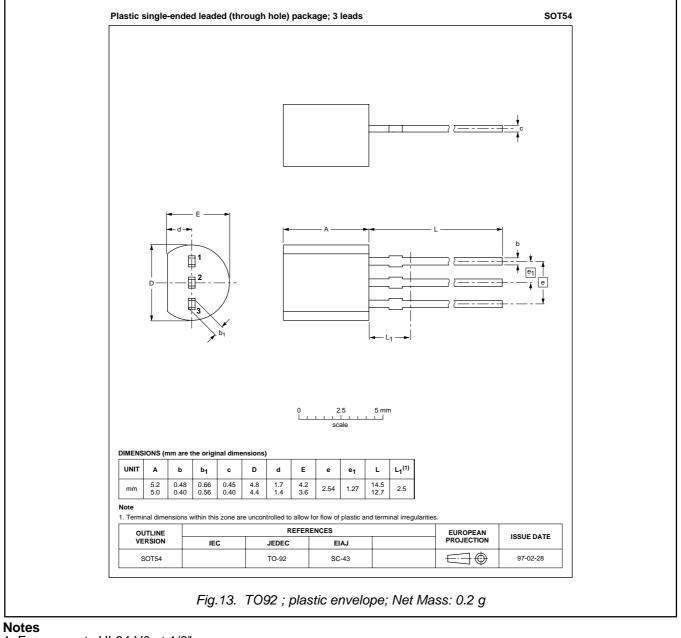
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MECHANICAL DATA



1. Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

DATA SHEET STATUS				
DATA SHEET PRODUCT STATUS ² STATUS ³		DEFINITIONS		
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice		
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product		
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A		

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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² Please consult the most recently issued datasheet before initiating or completing a design.

³ The product status of the device(s) described in this datasheet may have changed since this datasheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.